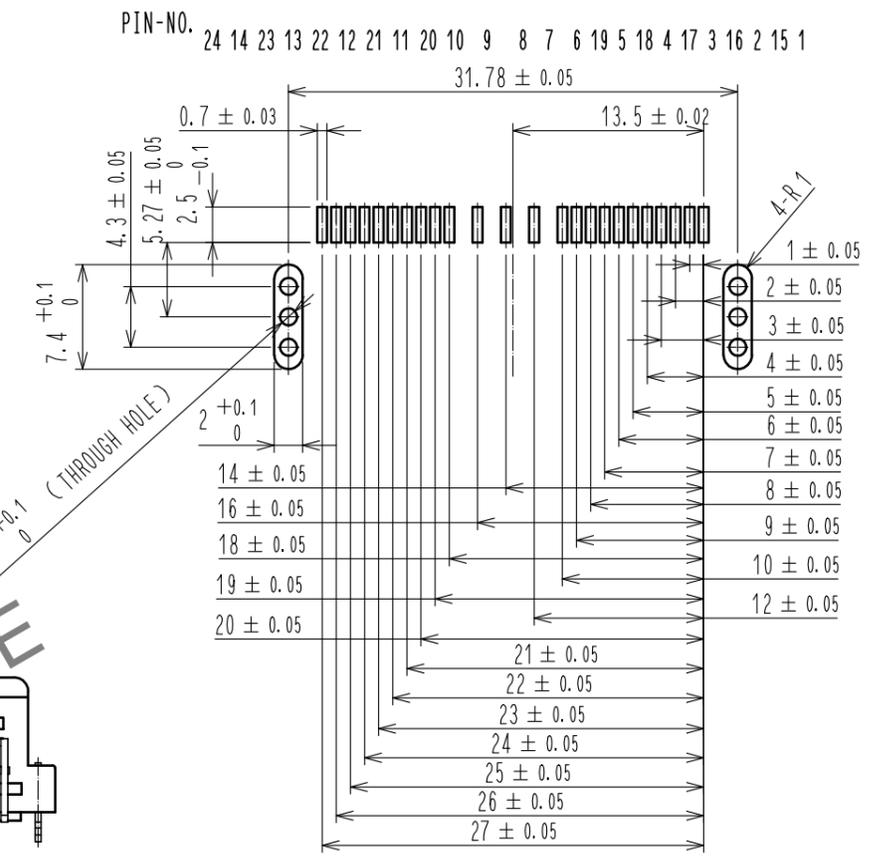
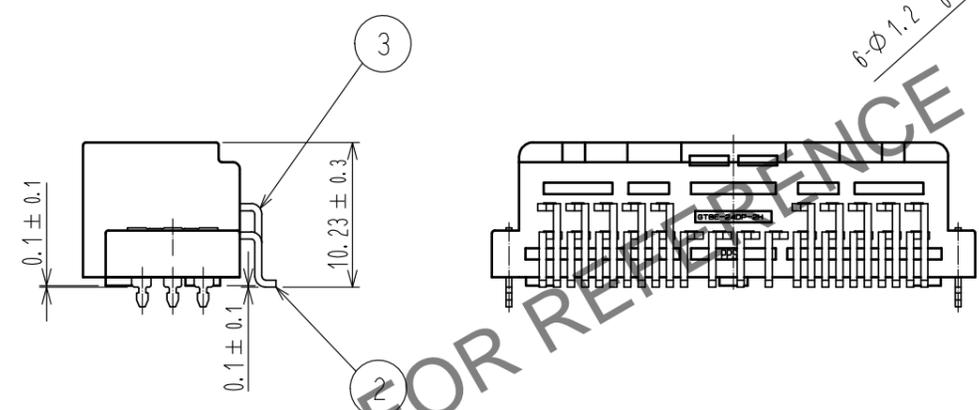
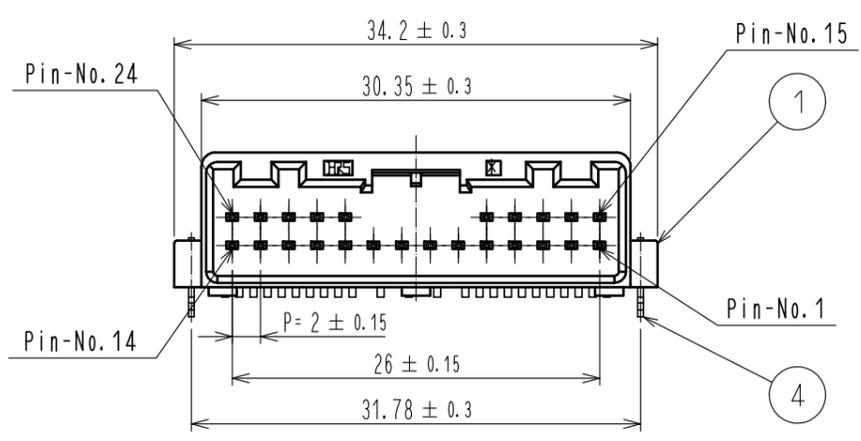
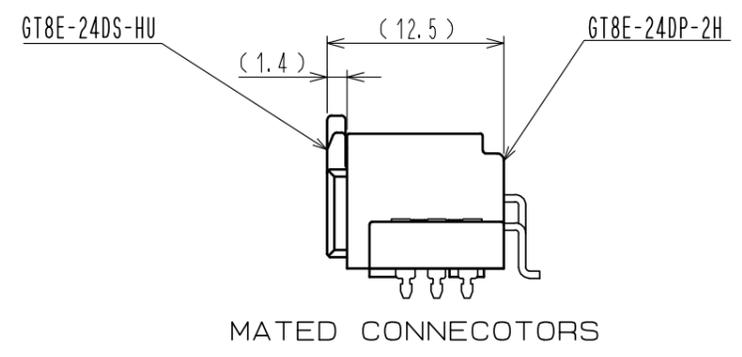
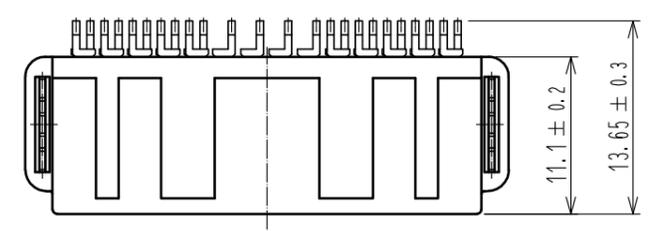
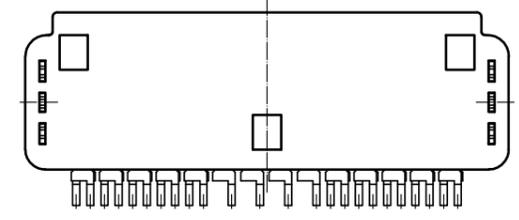


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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

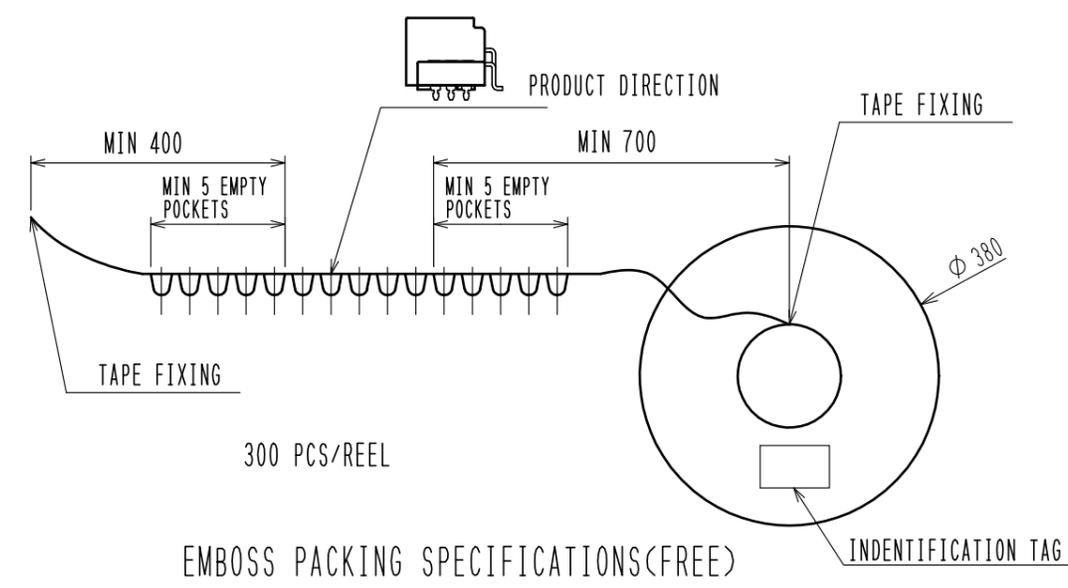
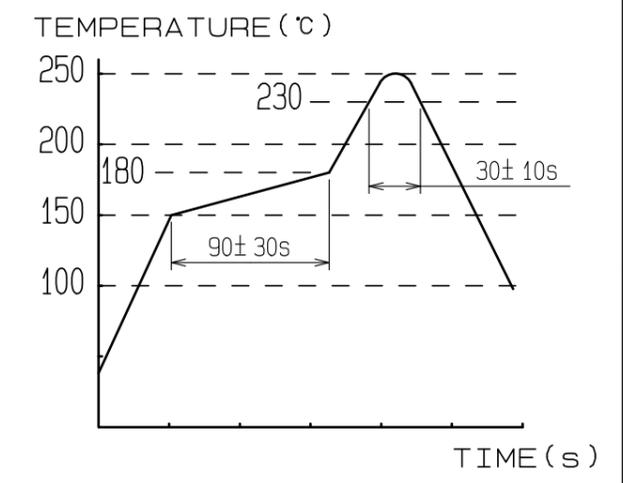
ELV, RoHS COMPLIANT



RECOMMENDED PC BOARD PATTERN (CONNECTOR SIDE)



- NOTE 1. RECOMMENDED REFLOW TEMPERATURE PROFILE (REFER RIGHT FIG.).  
 REFLOW HEATING: FAR-INFLARED, IN THE AIR OR NITROGEN  
 NUMBER OF REFLOW CYCLES: 2 CYCLES MAX  
 PEAK TEMPERATURE: 250°C  
 ABOVE 230°C: 20~40s  
 PREHEAT: 150~180°C (60~120s)  
 2. SOLDERING TEMPERATURE: 280~300°C (MAX 2s)  
 3. COPLANARITY OF LEADS SHALL BE 0.1mm MAX.  
 4. RECOMMENDED THICKNESS FOR PC BOARD IS 1.6mm.  
 5. RECOMMENDED THICKNESS FOR SOLDER PASTE IS 0.15mm.



2	BRASS	TIN PLATING	4	BRASS	TIN PLATING
1	PPS	BLACK	3	BRASS	TIN PLATING
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 	DESCRIPTION OF REVISIONS	DESIGNED
<b>HRS</b> HIROSE ELECTRIC CO., LTD.		APPROVED : HH. TSUKUMO	20200321	DRAWING NO.	EDC-167887-55-00
		CHECKED : HH. TSUKUMO	20200321	PART NO.	GT8E-24DP-2H(55)
		DESIGNED : DONGCHAN KIM	20200318	CODE NO.	CL758-1011-7-55
		DRAWN : YK. MITSUISHI	20200318		1/1